

Customer Information Notification

Issue Date:23-Feb-2020Effective Date:24-Feb-2020

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QUALITY

Change Category

[] Wafer Fab Process

[] Wafer Fab Materials

[] Wafer Fab Location

[] Firmware

MC33926 Data Sheet Update to Rev 16 (28-pin HVQFN Clarifications)

[] Assembly[] Product Marking []Test [] Design Process Location []Test [] Assembly [] Mechanical [] Errata Materials Specification Process [] Assembly[] [] Test [] Electrical Packing/Shipping/Labeling Equipment spec./Test Location coverage

[X] Other - Data Sheet Update - Clarification

Description

NXP Semiconductors announces the data sheet update to revision 16 for the MC33926 devices associated with this notification. The revision history included in the updated document provides a detailed description of the changes. Changes are summarized below.

Data Sheet Changes:

- 1. Figure 4: updated 28-pin HVQFN pin configuration to indicate four corner pads as AGND
- 2. Section 13.1: added 28-pin HVQFN solder mask information

** Documentation change only for customer clarification - absolutely no changes to the device / product **

New MC33926 revision 16 data sheet is attached to this notice, and can be found at: https://www.nxp.com/docs/en/data-sheet/MC33926.pdf

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02 **Reason**

The data sheet has been updated to provide additional technical clarification regarding 28-pin HVQFN corner pad labels, and solder mask diagram.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

 For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team. About NXP Semiconductors

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Outline	Package Name	Status	Product Line
MC33926PNBR2	935311694528	MC33926PNB	TTHROTTLE CONTROL H-BRI	SOT1633-1	HQFN32	RFS	Driver & Energy Systems
MC33926PNB	935311694557	MC33926PNB	TTHROTTLE CONTROL H-BRI	SOT1633-1	HQFN32	RFS	Driver & Energy Systems